

## Special Issue

# Tactile Sensing Technology and Systems

### Message from the Guest Editor

Tactile sensors acquire tactile information through physical touch; measurands are, for example, temperature, vibration, softness, texture, shape, composition and shear and normal forces.

Electronic/artificial skin comprises embedded electronic systems which integrate tactile sensing arrays, signal acquisition, data processing and decoding, and can transmit collated information. Such electronic/artificial skin will become one of the main sensing essentials in prosthetics, bionics, robotics, virtual reality, haptic devices, IoT, etc. In this Special Issue, we focus on both insights and advancements in tactile sensing with the goal of bridging different research areas, e.g., material science, electronics, robotics, neuroscience, mechanics, sensors, MEMS/NEMS, additive and 3D manufacturing, bio and neuro-engineering. We would like to receive commentaries, perspectives and insightful reviews on related topics as well as technological breakthroughs of original works, civil and industrial applications in both short communications and full papers.

### Guest Editor

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### Deadline for manuscript submissions

closed (31 August 2019)



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